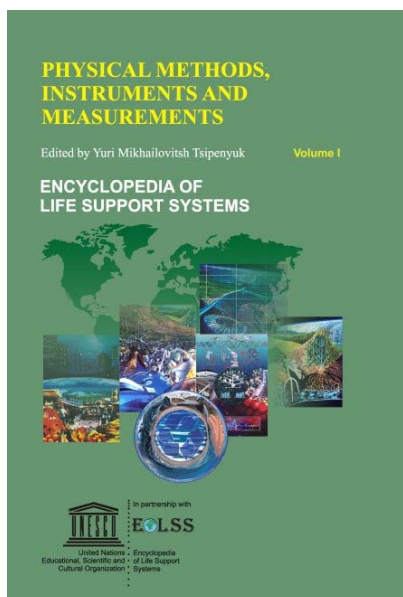


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PHYSICAL METHODS, INSTRUMENTS AND MEASUREMENTS



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